



# Product Change Notification

## 109281 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 109281 - 01  
**Change Title:** Intel(R) Server System S7000FC4UR, PCN 109281-01, Product Design, AFCPROCHS - Processor heat sink changes, Reason for Revision: Roadmap update  
**Date of Publication:** July 28, 2009

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Aug 28, 2009
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## Description of Change to the Customer:

### Reason for Revision: Roadmap update

AFCPROCHS

1. Adding 0.075" to the length of the screws in heat sink to improve usability.
2. Heat sink supplier is changing factory location from Taiwan to China mainland.
3. Over pack label changes.

## Customer Impact of Change and Recommended Action:

This change has no significant impact to customer.

## Products Affected / Intel Ordering Codes:

Pre Conversion Product Code	Pre Conversion MM#	Pre Change TA	Post Change MM#	Post Change TA
AFCPROCHS	891013	D94024-001	891013	D94024-002

## Reference Documents / Attachments:

**Document:** **Location #:**

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 15, 2009	00	Originally Published PCN
July 28, 2009	01	Roadmap update

